

PCN # 09_0037 Qual Plan

TEST	CONDITIONS	SAMPLE SIZE	EXPECTED COMPLETION DATE
Temperature Cycle*	JEDEC JESD22-A104	3x77	02/Sep/09
Solder Heat Resistance*	ADI-0049	3x10	02/Sep/09
Mechanical Shock-Powered	IEC 68 Part 2-27	3x10	02/Sep/09
Random Drop	CAM0091	3x35	02/Sep/09
Shock/Vib./Cent./Seal	Mil-Std-883 Method 5005 Subgroup4	3x15	02/Sep/09

*Preconditioned Per JEDEC/IPC J-STD-020